

LINEAR TECHNOLOGY MATERIALS DECLARATION

1tc2372huh-16#trpbf

(Engineering Calculation)

QFN 5mm X 5mm Exp. Pad

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TOTAL MASS (g) : 0.065241

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002549	1000000	39070.3632812		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.028382	975000	435031.375		
		Iron (Fe)	7439-89-6	0.000699	24000	10714.0771484		
		Phosphorus (P)	7723-14-0	0.000009	300	137.949493408		
		Zinc (Zn)	7440-66-6	0.000020	700	306.554443359		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.029110	1000000	446189.96875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001398	1000000	21432.3828125		
		External Plating Total:				0.001398	1000000	21432.3828125
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000635	1000000	9733.10351562		
Internal Plating Total:				0.000635	1000000	9733.10351562		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001068	750000	16370.0058594		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000356	250000	5456.66894531		
Die Attach Total:				0.001424	1000000	21826.6757812		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.003888	130000	59594.1796875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.025723	860000	394274.9375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000299	10000	4582.98876953		
		Encapsulation Total:				0.029910	1000000	458452.125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000215	1000000	3295.45996094		
					TOTAL MASS (g) :	0.065241		